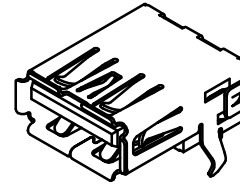
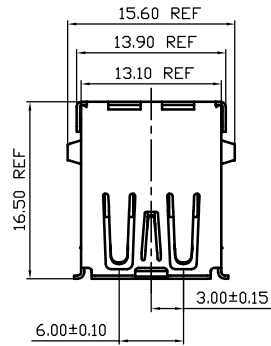


<4X> 1.00±0.05
 <2X> 1.00±0.05
 <2X> 3.50±0.05

2:1 DETAIL A



F

E

D

C

B

A

1

2

3

4

5

6

7

8

REV	MODIFICATION	DATE	DRAW

F

E

D

C

B

A

Note:

1.Material:

1.1 Insulator:High Temperature Plastic,UL94V-0

1.2 Contact:Copper Alloy

1.3 Shell:Copper Alloy

1.4 Contact Plated:

Contact Area Plated: 30u" Selective Gold Plated

Solder tails Plated: 150u" Tin Plated

Underplate: 50u" Nickel Plated

1.5 Shell Plated:

Underplate: 40u" Nickel Plated

Outside: 100u" Bright Tin

2.Specification:

2.1 Contact resistance : 30m ohms Max

2.2 Dielectric Strength: 100Volts AC(RMS)

2.3 Insulation Resistance:100M ohms Min

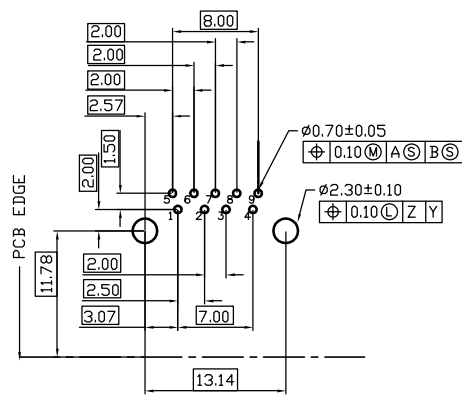
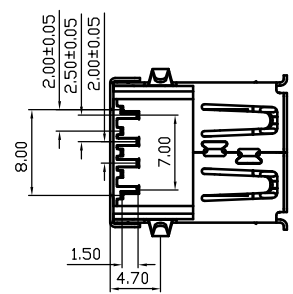
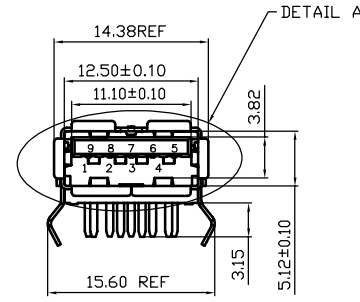
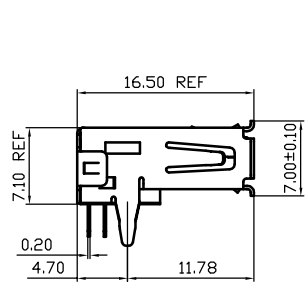
2.4 Insertion force:35 Newtons max.

2.5 Extraction force:10 Newtons min.

Order Information

USBRI-A09 XX BT00

30:30u" GOLD PLATING



REFERENCE P.C.B. LAYOUT

DIMENSION IN mm [Inch]	PROD. SPEC.	C	
TOLERANCE UNLESS OTHERWISE SPECIFIED	PKG. SPEC.	TITLE USB 3.0 A TYPE	
.X±0.30	X.*±	CUSTOMER DRAWING	
.XX±0.20	.X*±	FILE NO. KFP-127	DWG NO. USBRI-A09XXBT00
.XXX±0.10	.XX*±	SIZE A4	PROJ. SHEET 1 / 1
		SCALE 1:1	REV XA

1

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3

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8F-06-R02